Call for Nominations: Interpacket Achievement Award for 2020

Dear InterPACK Community,

Nominations are solicited for the prestigious InterPACK Achievement Award, to be awarded at the InterPACK 2020 Conference to be held from Oct. 27th through Oct. 29th, 2020 in a virtual format.

The InterPack Achievement Award is given to a single individual at each ASME InterPACK Conference. Candidates should have demonstrated excellence and achieved international recognition in the area of research and development related to electronic packaging, as well as demonstrated a high level of service to the technical community at large. Scientific and technical leadership can be demonstrated by multiple means including publications, patents awarded, technologies and products developed, and students advised. Candidates must also have a demonstrated leadership role in InterPACK over the years, such as organizational leadership, track leadership, session chairing, paper presentations and reviews.

Previous winners include:
1999  Alan Kraus, Naval Postgraduate School
2001  Prof. Wataru Nakayama, ThermTech International & Tokyo Institute of Technology
2003  Richard Chu, IBM Corporation
2005  Prof. Avram Bar-Cohen, University of Maryland
2007  Prof. Dereje Agonafer, University of Texas at Arlington
2009  Prof. Yogendra Joshi, Georgia Institute of Technology
2013  Prof. Y.C. Lee, University of Colorado
2015  Prof. Bahgat G. Sammakia, Binghamton University
2017  Prof. Ken Goodson, Stanford University
2018  Dr. Ravi Mahajan, Intel Corporation
2019  Prof. Abhijit Dasgupta, University of Maryland

The nomination package should include:
1. Cover letter from nominator(s)
2. One-page justification of the candidacy
3. Two-page summary resume including the candidate's career highlights as well as complete contact information.
4. Two reference letters (including the one from the nominator)

Please send the nomination package to the following members of the Award Committee no later than Sep. 14th, 2020, 5:00 PM US Pacific Time.

Prof. Y.C. Lee, (y.c.lee@Colorado.EDU)
Prof. Alfonso Ortega, (alfonso.ortega@villanova.edu)
Dr. Rama Ramakrishna, (koneru_rama@yahoo.com)
Prof. Yogendra Joshi, (yogendra.joshi@me.gatech.edu)

Incomplete nominations or those submitted after the deadline will not be considered. We would like to thank you on behalf of the InterPACK Organizing Committee for participating in the nominations process.